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Assistant Commissioner for Patents,  
Washington, D.C. 20231,

PATENT  
Attorney Docket No.: AM1126D1/T08910

*September 16, 1999*

TOWNSEND and TOWNSEND and CREW LLP

By *James L. Crook*



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

|  |   |                                 |
|--|---|---------------------------------|
| In re application of:                  | ) | Examiner: Unassigned            |
|  | ) |                                 |
| Kramadhati V. Ravi et al               | ) | Art Unit: 2812                  |
|  | ) |                                 |
| Application No.: 09/362,504            | ) |                                 |
|  | ) | <u>CHANGE OF CORRESPONDENCE</u> |
| Filed: July 27, 1999                   | ) | <u>ADDRESS</u>                  |
|  | ) |                                 |
| For: Method For Reducing The Intrinsic | ) |                                 |
| Stress of High Density Plasma Films    | ) |                                 |

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Please change the correspondence address for the above-identified application as follows:

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Respectfully submitted,

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